As a below named Inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled A Method To Improve Passivation Openings By Reflow Of Photoresist To Eliminate Tape Residue

the specification of which (check one)			
X is attached hereto.			
was filed on			
Application Serial No.			
and was amended on(if appl	Parkin		
I hereby state that I have reviewed and uncamended by any amendment referred to ab	lerstand the contents of the allove.	pove Identified specification including the cla	ums, as
I acknowledge the duty to disclose informa 37, Code of Federal Regulations, §1.56(a).	ation which is material to the	examination of this application in accordance	with Title
inventor's certificate listed below and have a filing date before that of the application of	er Title 35, United States Coe also identified below any for on which priority is claimed:	de §119 of any foreign application(s) for pate eign application for patent or inventor's certif	ent or ficate having
Prior Foreign Application(s)		Priority Claimed:	
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[] (Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
as the subject matter of each of the claims provided by the first paragraph of Title 35, defined in Title 37, Code of Federal Regula mational or PCT international filing date of	of this application is not discluding the United States Code, §112, I ations, §1.56(a) which occurre this application:	osed in the prior United States application in acknowledge the duty to disclose material in ed between the filing date of the prior application.	the manner formation as ation and the
(Application Serial No.)	Filing Date) (Status)	(patented, pending, abandoned)	
Thereby declare that all statements made helief are believed to be true; and further the	nat these statements were mad	re true and that all statements made on informate with the knowledge that willful false states Section 1001 of Title 18 of the United States cation or any patent issued thereon.	ments and
POWER OF ATTORNEY: As a named in application and transact all business in the	ventor, I hereby appoint the for Patent and Trademark Office	ollowing attorney(s) and/or agent(s) to prose connected therewith. (list name & registration	cute this
GEORGE 0. SAILE. (Reg. No. 1	9,572), STEPHEN B. A	CKERMAN (Reg. No. 37,761)	
Send Correspondence to: 20 MCINTOSH	DRIVE, POUGHKEEPSIE;	NEW YORK 12603	
Direct telephone Calls to: (name & telephone	number) GEORGE 0. SAI	LE NEW YORK 914 452 5863	
Full name of sole or first inventor		Date	
Hung-Jon Wen Inventor's signature		7/>> 2000	
Residence Residence	Rd. Sec. 3, Chi	ung-Ho Crey Taiper Coun	ty, Taiwah.
Citizenship	of China, Tamo	Щ	
Post Office Address Scien	ice Based Ind P	Park Hsin-Chu, Tainar	L.

Yu- Kung Hsia B. Jul-22-	-2000
Full name of second inventor	-
Investor's signature	-
No. 25 Lane 14 Ying - Yu Street 3 Yang - Mei Tar-Yuan, Taiwan	
R.O.C. Republic of China Taiwan	-
Building 67, 195, Chung-Hsing Rd., Sec. 4, Chu-Tung, Hsin-Chu 3, Post Office Address	10, laiwan R.O.C
CHZH-KUNG CHANG. Full name of third inventor Date	0
Inventor's signature	-
42. Alley 21. Lane 221, Churg-Hing Rd. Sec. 2, Chu-Tung, 14sin-Chu-10, Te Residence	inean, R.D.C.
Citizenship Republic of China, Tarwan	-
Building 67, 195, Chung - King Rd., See 4, Chu-Tung, Hin-Chu 310, Taiwan	z, R.C.C.
SHENG - LIANG PAN Full name of fourth inventor Date	-
SHENG - LIANG PAN Jul-22	2000
Inventor's signature 4F, No. 14, Lone 43, Pa - Inn St., Hsin - Chu, Taiwan Residence	**
Residence Republic of China, Taxwan	
* Citimonalia	_
Building 67, 195, Chang-Hein Rd., Sec. 4, Cha-Tung, Hein-Chang-Office Address	u 310, Taiwan, R.O.(
- Kuo-Liang Lu Jul22-2000	-
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III NO. 9. Road 3. BO-Chuan. CARC-Wian Ki. MSin-Cleux A	aiwan
1 R.O. C Republic of China, Taiwan	_
Citizenship Building 67 195, Chung-HSin Rd. Sec. 4. Chu-Tung	, Asin-Chu310, Tarw
Post Office Address	Raci
Full name of sixth inventor Date	-
Inventor's signature	_
Residence	
Citizenship	-
Post Office Address	-